

Weight	Wire Diameter	Order Code	Price Per Reel	
			1+	5+
250g Reels	0.5mm	101-5452	1,534.00	1,382.00
	0.7mm	101-5453	1,121.00	1,009.00
	1mm	101-5454	1,011.00	911.00
	1.2mm	101-5455	1,007.00	906.00
500g Reels	0.7mm	101-5456	2,167.00	1,951.00
	1mm	101-5457	1,948.00	1,754.00
	1.2mm	101-5458	1,939.00	1,746.00

Lead Free Alloy, Mildly Activated No-Clean Flux
New alloy: Tin (97.1%), Silver (2.6%), Copper (0.3%)



- Mildly activated no-clean flux formulation
- Contains 5 cores of flux
- Increased flux content (2.7% by weight) - low fuming and low spitting
- Minimal clear residues, do not require cleaning



- Complies with all lead-free legislative requirements
- Suitable for general lead-free, no-clean assembly, or rework of PCBs assembled in a lead-free no-clean process

Alloy	Sn97.1Ag2.6Cu0.3	Melting Temperature	217°C - 224°C
Flux Type	Mildly activated, no-clean	Tip Temperature (Approx.)	350°C - 370°C

416065

Weight	Wire Diameter	Order Code	Price Per Reel	
			1+	5+
250g Reels	0.5mm	101-5459	1,428.00	1,285.00
	0.7mm	101-5460	1,040.00	936.00
	1mm	101-5462	941.00	846.00
	1.2mm	101-5463	935.00	841.00
500g Reels	0.7mm	101-5464	2,016.00	1,814.00
	1mm	101-5465	1,811.00	1,629.00
	1.2mm	101-5466	1,803.00	1,623.00

Lead-Free Alloy, High Activity Rosin Flux
New alloy: Tin (97.1%), Silver (2.6%), Copper (0.3%)



- Contains 5 cores of halide-activated rosin based flux
- Pale coloured residues do not require cleaning
- Extra wetting properties for faster soldering



- For all general purpose lead-free electronic assembly and re-work applications
- Complies with all lead-free legislative requirements

Alloy	Sn97.1Ag2.6Cu0.3
Flux Type	Halide-activated rosin-based flux
Melting Temperature	217°C - 224°C
Tip Temperature (Approx.)	350°C - 370°C

416070

Weight	Wire Diameter	Order Code	Price Per Reel	
			1+	5+
250g Reels	0.5mm	101-5467	1,444.00	1,300.00
	0.7mm	101-5468	1,052.00	947.00
	1mm	101-5469	950.00	854.00
	1.2mm	101-5470	945.00	850.00
500g Reels	0.7mm	101-5471	2,037.00	1,833.00
	1mm	101-5472	1,830.00	1,647.00
	1.2mm	101-5474	1,822.00	1,640.00

Solder Dispensers

Dispenser for 500g Solder Reels



- Wire is fed through a dispensing tube
- Friction mount prevents reel running on
- Suitable for all gauges of 500g reels

212669

Mfrs. List No.	Order Code	Price Each
SD1000	419-606	1,975.00

Solder Fluxes, Pastes & Chemicals

Surface Mount



SMSP - Surface Mount Solder Paste

- Silver containing SM solder paste for manual and automatic dispensing
- Long tack time
- Bright shiny joints
- May be used as no-clean as residues are non-corrosive

SMA - Surface Mount Adhesive

- High green strength adhesive
- Solvent resistant
- Thixotropic nature gives high dot profile
- Medium strength final bond
- Heat curing
- May be manually or automatically dispensed
- Store below 5°C

Note: Shelf life is 6 months at 20°C, 12 months at 5°C. Refrigerated storage is recommended.

SMFL/SMF - Surface Mount Rework Flux

- Quick drying flux to aid rework
- Use prior to desoldering to aid component removal
- MIL approved no-clean flux
- Non-tacky, non-corrosive residue

Note: Aerosol contains flammable contents. Do not use on live equipment or near any source of ignition. Use in a well ventilated area.

SOL172/212521

	Mfrs. List No.	Order Code	Price Each			
			1+	5+	10+	20+
10ml Syringe	SMSP105	635-121	867.00	820.00	785.00	747.00
10ml Syringe	SMA10SL	106-610	1,155.00	1,098.00	1,052.00	--
12ml Pen	SMF12P	891-186	386.00	364.00	334.00	--
			1+	5+	12+	
200ml Aerosol	SMFL200D	298-311	666.00	634.00	607.00	

Flux Pen

BONKOTE

Refillable



- Refillable pen sized tool for applying liquids
- Sealed cartridge prevents evaporation
- Brush fibre tip for controlled application
- Ideal for applying flux but may be used in many applications

Capacity 7ml
Tip length 14mm
Tip diameter 4.3mm, tapers to a point

Contains parts made from
Polypropylene
Polyester
Polyethylene

212527

Mfrs. List No.	Order Code	Price Each			
		1+	5+	10+	+
BON102	500-896	990.00	941.00	874.00	--

Tip Tinner/Cleaner - TTC1



- Quick and effective method of cleaning and re-tinning de-wetted soldering irons
- Compacted disc of electronics grade solder powder and chemicals
- Will remove stubborn tin/iron intermetallic layer that forms on iron plated tips and resists rosin based fluxes
- Contains non-corrosive chemicals with a low evaporation point leaving no residues
- Single wipe of the iron across the surface cleans/wets and tins the tip at once

212686

Mfrs. List No.	Order Code	Price Each	
		1+	10+
TTC1	419-631	325.00	302.00

Soldering

25

Compliant
Non-compliant
RoHS
+ Limited stock - RoHS replacement available